

3HE05752AB-OPC

Alcatel-Lucent Nokia® 3HE05752AB Compatible TAA 100GBase-LR4 CFP Transceiver (SMF, 1310nm, 10km, LC, DOM)

Features

- CFP MSA 1.4 Compliance
- Duplex LC Connector
- Commercial Temperature 0 to 70 Celsius
- Single-mode Fiber
- Hot Pluggable
- Excellent ESD Protection
- Metal with Lower EMI
- RoHS Compliant and Lead Free



Applications:

- 100GBase Ethernet
- OTU4 Operation
- Access and Enterprise

Product Description

This Alcatel-Lucent Nokia® 3HE05752AB compatible CFP transceiver provides 100GBase-LR4 throughput up to 10km over single-mode fiber (SMF) using a wavelength of 1310nm via an LC connector. It is guaranteed to be 100% compatible with the equivalent Alcatel-Lucent Nokia® transceiver. This easy to install, hot swappable transceiver has been programmed, uniquely serialized and data-traffic and application tested to ensure that it will initialize and perform identically. Digital optical monitoring (DOM) support is also present to allow access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Storage Temperature	TS	-40	+85	°C
Power Supply Voltage	VCC	-0.5	3.6	V
Operating Case Temperature Range	Tc	-10	+75	°C
Relative Humidity	Rh	5	85	%

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	
Power Supply Voltage	VCC	3.2	3.3	3.4	V	
Power Supply Current	Icc		4000		mA	
Transmitter						
Differential data input swing	Vin			1050	mVp-p	
Input differential impedance	Zin	80	100	120	Ω	
Receiver						
Differential data output swing	Vout, pp	360		770	mVp-p	
Output differential impedance	Zo	80	100	120	Ω	
Output Rise/Fall Time	tr/tf	24			ps	20%~80%

1.2V MDIO Interface Specifications

Parameter	Symbol	Min.	Typ.	Max	Unit	Notes
Input Voltage	VIH	0.84		1.5	V	
	VIL	-0.3		0.36	V	
Input Leak current	IIN	-100		100	uA	
Output Voltage	VOH	1.0		1.5	V	
	VOL	-0.3		0.2	V	
Input Capacitance	CI			10	pF	
Input MDC Clock	fMDC	0.1		4	MHz	
MDC Clock Period	TMDC	250		10000	ns	
MDIO Hold Time	Thold	10			ns	
MDIO Setup Time	Tsetup	10			ns	
GLB_ALM	Tglb_alm_ass			150	ms	
	Tglb_alm_dea			150	ms	

OTU4 4I1-9D1F Operation Optical Characteristics

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Transmitter						
Signaling Speed per Lane	BRAVE		27.95		Gbps	
Lane_0 Center Wavelength	λ_{C0}	1294.53	1295.56	1296.59	nm	
Lane_1 Center Wavelength	λ_{C1}	1299.02	1300.05	1301.09	nm	
Lane_2 Center Wavelength	λ_{C2}	1303.54	1304.58	1305.63	nm	
Lane_3 Center Wavelength	λ_{C3}	1308.09	1309.14	1310.19	nm	
Total Average Output Power	PO1	-		8.9	dBm	1, 2
Average Launch Power per Lane	Peach1	-2.5		2.9	dBm	2
Side Mode Suppression Ratio	SMSR	30			dB	
Optical Return Loss Tolerance				20	dB	
Extinction Ratio	ER1	7			dB	2
Transmitter eye mask definition {X1, X2, X3, Y1, Y2, Y3}		G.959.1 Compliant				2
TX Disable Assert Time	t_off			100	us	
Receiver						
Signaling Speed per Lane	BRAVE		27.95		Gbps	
Lane_0 Center Wavelength	λ_{C0}	1294.53	1295.56	1296.59	nm	
Lane_1 Center Wavelength	λ_{C1}	1299.02	1300.05	1301.09	nm	
Lane_2 Center Wavelength	λ_{C2}	1303.54	1304.58	1305.63	nm	
Lane_3 Center Wavelength	λ_{C3}	1308.09	1309.14	1310.19	nm	
Average Receive Power per Lane	Rpow1	-8.8		4	dBm	5
Equivalent Sensitivity per Lane	Pmin1			-10.3	dBm	7
Receiver Overload per Lane	Pmax	5.5			dBm	
Optical Return Loss	ORL			-26	dB	
LOS Assert	LOSA	-21			dBm	
LOS De-Assert	LOSD			-11	dBm	
LOS Hysteresis		0.5			dB	

100GBASE-LR4 Operation Optical Characteristics

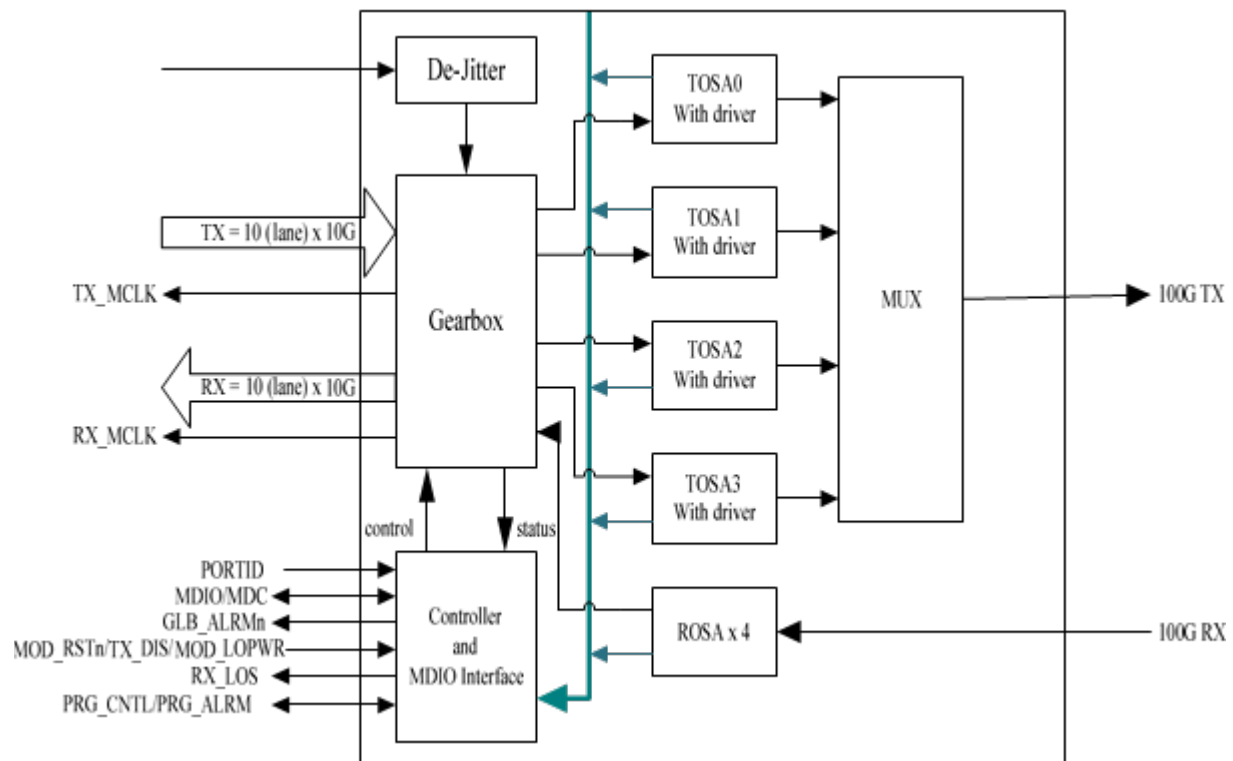
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Transmitter						
Signaling Speed per Lane	BRAVE		25.78		Gbps	
Lane_0 Center Wavelength	λ_{C0}	1294.53	1295.56	1296.59	nm	
Lane_1 Center Wavelength	λ_{C1}	1299.02	1300.05	1301.09	nm	
Lane_2 Center Wavelength	λ_{C2}	1303.54	1304.58	1305.63	nm	
Lane_3 Center Wavelength	λ_{C3}	1308.09	1309.14	1310.19	nm	
Total Average Output Power	PO2	-		10.5	dBm	1, 4
Average Launch Power per Lane	Peach2	-4.3		4.5	dBm	4
Side Mode Suppression Ratio	SMSR	30			dB	
Optical Return Loss Tolerance				20	dB	
Extinction Ratio	ER2	7			dB	4
Transmitter eye mask definition {X1, X2, X3, Y1, Y2, Y3}		IEEE802.3ba-2010 Compliant				4
TX Disable Assert Time	t_off			100	us	
Receiver						
Signaling Speed per Lane	BRAVE		25.78		Gbps	
Lane_0 Center Wavelength	λ_{C0}	1294.53	1295.56	1296.59	nm	
Lane_1 Center Wavelength	λ_{C1}	1299.02	1300.05	1301.09	nm	
Lane_2 Center Wavelength	λ_{C2}	1303.54	1304.58	1305.63	nm	
Lane_3 Center Wavelength	λ_{C3}	1308.09	1309.14	1310.19	nm	
Average Receive Power per Lane	Rpow2	-10.6		4.5	dBm	6
Receive Sensitivity (OMA) per Lane	Pmin2			-8.6	dBm	8
Stressed Sensitivity (OMA) per lane	SRS			-6.8	dBm	
Receiver Overload per Lane	Pmax	5.5			dBm	
Optical Return Loss	ORL			-26	dB	
LOS Assert	LOSA	-21			dBm	
LOS De-Assert	LOSD			-11	dBm	
LOS Hysteresis		0.5			dB	

Notes:

1. Output is coupled into a 9/125μm single-mode fiber.
2. Filtered, measured with a PRBS 2³¹-1 test pattern @27.95Gbps
3. High speed I/O, internally AC coupled.
4. Filtered, measured with a PRBS 2³¹-1 test pattern @25.78Gbps
5. CFP transceiver works in OTU4 4I1-9D1F mode.
6. CFP transceiver works in 100GBASE-LR4 mode.

7. Minimum average optical power measured at BER less than $1E-12$, with a $2^{31}-1$ PRBS@27.95Gbps.
8. Minimum OMA optical power measured at BER less than $1E-12$, with a $2^{31}-1$ PRBS@25.78Gbps.

Functional Description of Transceiver



Electrical Pad Layout



Pin Descriptions

Part A: Bottom Row Pin Function Definition

Pin	Name	Function	Notes
1	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
2	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
3	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
4	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
5	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
6	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
7	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
8	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
9	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
10	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
11	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
12	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
13	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
14	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
15	3.3V	3.3V Module Supply Voltage	3.3V $\pm$ 2.5%
16	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
17	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
18	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
19	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
20	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
21	VND_IO_A	I/O	Module Vendor I/O, NC
22	VND_IO_B	I/O	Module Vendor I/O, NC
23	GND	Ground	Signal Ground
24	(TX_MCLKn)	Tx Monitor Clock O	Tx Monitor Clock Output
25	(TX_MCLKp)	Tx Monitor Clock O	Tx Monitor Clock Output
26	GND	Ground	Signal Ground
27	VND_IO_C	I/O	Module Vendor I/O, must not connect at host board
28	VND_IO_D	I/O	Module Vendor I/O, must not connect at host board
29	VND_IO_E	I/O	Module Vendor I/O, must not connect at host board
30	PRG_CNTL1	I	LVCOMS
31	PRG_CNTL2	I	LVCOMS
32	PRG_CNTL3	I	LVCOMS
33	PRG_ALRM1	O	LVCOMS
34	PRG_ALRM2	O	LVCOMS
35	PRG_ALRM3	O	LVCOMS
36	TX_DIS	Transmitter Disable I	"1" or NC = transmitter disabled, "0" = transmitter enabled
37	MOD_LOPW R	Module Low Power Mode I	"1" or NC: module in low power (safe) mode, "0": power-on enabled
38	MOD_ABS	Module Absent O	"1" or NC: module absent, "0": module present
39	MOD_RSTn	Module Reset I	"0" resets the module, "1" or NC = module enabled
40	RX_LOS	Loss of Signal O	"1": low optical signal, "0": normal condition

41	GLB_ALRMn	Global Alarm O	"0": alarm condition in any MDIO Alarm register, "1": no alarm condition
42	PRTADR4	1.2V CMOS I	MDIO Physical Port address bit4
43	PRTADR3	1.2V CMOS I	MDIO Physical Port address bit3
44	PRTADR2	1.2V CMOS I	MDIO Physical Port address bit2
45	PRTADR1	1.2V CMOS I	MDIO Physical Port address bit1
46	PRTADR0	1.2V CMOS I	MDIO Physical Port address bit0
47	MDIO	1.2V CMOS I/O	Management Data I/O bi-directional data
48	MDC	1.2V CMOS I	Management Data Clock
49	GND	Ground	Signal Ground
50	VND_IO_F	I/O	Module Vendor I/O, Not Connected Internally
51	VND_IO_G	I/O	Module Vendor I/O, Not Connected Internally
52	GND	Ground	Signal Ground
53	VND_IO_H	I/O	Module Vendor I/O, Not Connected Internally
54	VND_IO_J	I/O	Module Vendor I/O, Not Connected Internally
55	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
56	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
57	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
58	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
59	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
60	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
61	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
62	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
63	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
64	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
65	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
66	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
67	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
68	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
69	3.3V	3.3V Module Supply Voltage	3.3V ± 2.5%
70	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
71	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
72	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
73	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
74	3.3V_GND	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground

Part B: Top Row Pin Function Definition

Pin	Name	Function	Notes
148	GND	Ground	Signal Ground
147	REFCLKn	Reference Clock I	Reference Clock Input
146	REFCLKp	Ground	3.3V Module Supply Ground, Internally connected to Signal Ground
145	GND	Ground	Signal Ground
144	N.C.		Not Connected Internally
143	N.C.		Not Connected Internally
142	GND	Ground	Signal Ground
141	TX9n	Lane 9 Tx Input I	

140	TX9p	Lane 9 Tx Input I	
139	GND	Ground	Signal Ground
138	TX8n	Lane 8 Tx Input I	3.3V ± 2.5%
137	TX8p	Lane 8 Tx Input I	3.3V ± 2.5%
136	GND	Ground	Signal Ground
135	TX7n	Lane 7 Tx Input I	3.3V ± 2.5%
134	TX7p	Lane 7 Tx Input I	3.3V ± 2.5%
133	GND	Ground	Signal Ground
132	TX6n	Lane 6 Tx Input I	
131	TX6p	Lane 6 Tx Input I	
130	GND	Ground	Signal Ground
129	TX5n	Lane 5 Tx Input I	
128	TX5p	Lane 5 Tx Input I	
127	GND	Ground	Signal Ground
126	TX4n	Lane 4 Tx Input I	
125	TX4p	Lane 4 Tx Input I	
124	GND	Ground	Signal Ground
123	TX3n	Lane 3 Tx Input I	
122	TX3p	Lane 3 Tx Input I	
121	GND	Ground	Signal Ground
120	TX2n	Lane 2 Tx Input I	
119	TX2p	Lane 2 Tx Input I	
118	GND	Ground	Signal Ground
117	TX1n	Lane 1 Tx Input I	
116	TX1p	Lane 1 Tx Input I	
115	GND	Ground	Signal Ground
114	TX0n	Lane 0 Tx Input I	
113	TX0p	Lane 0 Tx Input I	
112	GND	Ground	Signal Ground
111	GND	Ground	Signal Ground
110	N.C.		Not Connected Internally
109	N.C.		Not Connected Internally
108	GND	Ground	Signal Ground
107	RX9n	Lane 9 Rx Output O	
106	RX9p	Lane 9 Rx Output O	
105	GND	Ground	Signal Ground
104	RX8n	Lane 8 Rx Output O	
103	RX8p	Lane 8 Rx Output O	
102	GND	Ground	Signal Ground
101	RX7n	Lane 7 Rx Output O	
100	RX7p	Lane 7 Rx Output O	
99	GND	Ground	Signal Ground
98	RX6n	Lane 6 Rx Output O	
97	RX6p	Lane 6 Rx Output O	
96	GND	Ground	Signal Ground
95	RX5n	Lane 5 Rx Output O	
94	RX5p	Lane 5 Rx Output O	

Laser Emission

